

SINGLE CHIP RDS DEMODULATOR + FILTER

FEATURES

- VERY HIGH RDS DEMODULATION QUALITY WITH IMPROVED DIGITAL SIGNAL **PROCESSING**
- HIGH PERFORMANCE, 57KHz BANDPASS FILTER (8th ORDER)
- FILTER ADJUSTMENT FREE AND WITHOUT EXTERNAL COMPONENTS
- PURELY DIGITAL RDS DEMODULATION WITHOUT EXTERNAL COMPONENTS
- ARI (SK INDICATION) AND RDS SIGNAL **QUALITY OUTPUT**
- 4.332MHz CRYSTAL OSCILLATOR(8.664 and 17.328MHz OPTIONAL)
- LOW NOISE CMOS TECHNOLOGY
- LOW RADIATION

DESCRIPTION 2

The TDA7479 recovers the additional inaudible RDS information which is transmitted by FM radio broadcasting stations and operates in accordance with the

Figure 1. Packages



Table 1. Order Codes

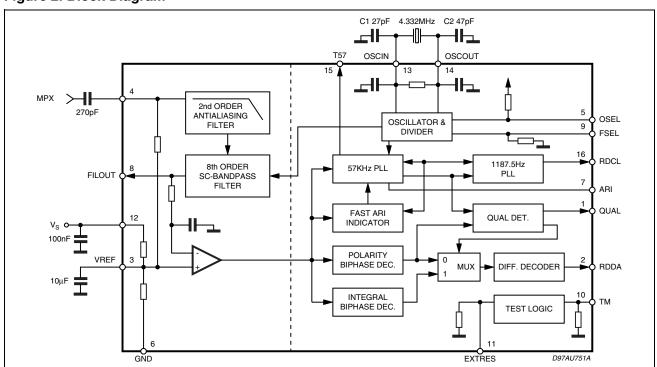
Part Number	Package
TDA7479D	SO16
TDA7479AD	TSSOP16

EBU (European Broadcasting Union) specifications.

The device is made up of two sections: a cascaded antialiasing + switched capacitors 8th bandpass filter for precise RDS band selection and a demodulating section that performs the extraction od RDS data stream (RDDA) and clock (RDCL), to be further processed by a suitable RDS decoder.

Outputs for RDS signal quality and ARI indication are also present.

Figure 2. Block Diagram



Rev. 6

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December 2004

Table 2. Pin Description

No pin	Name	Description			
1	QUAL	Output for signal quality indication (High = good)			
2	RDDA	RDS data output			
3	VREF	Reference voltage			
4	MPX	RDS input signal			
5	OSEL	Oscillator selector pin: - open, closed to V _S = quartz oscillator - closed to GND=external driven			
6	GND	Ground			
7	ARI	utput for ARI indication: nigh when RDS+ARI are present nigh when only ARI is present ow when only RDS is present undefined when nos signal is present			
8	FILOUT	Filter output			
9	FSEL	Frequency selector pin: -100K to $V_S = 17.328MHz$ - open = $4.332MHz$ - closed to $VS = 8.664MHz$			
10	TM	Test mode pin: - open = normal operation - closed to VS = testmode			
11	EXTRES	Reset pin: - open=run mode - closed to VS = reset condition			
12	Vs	Supply voltage			
13	OSCIN	Oscillator input			
14	OSCOUT	Oscillator output			
15	T57	Testing output pin: 57kHz clock output			
16	RDCL	RDS clock output 1187.5Hz			

Figure 3. Pin Connection (Top view)

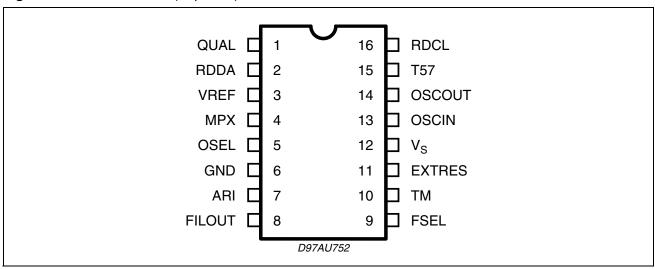


Table 3. Thermal Data

	Symbol	Description	SO16	TSSOP16	Unit
Ī	R _{th j-case}	Thermal Resistance Junction-case Max.	200	160	°C/W



Table 4. Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
Vs	Supply Voltage	-0.3 to 7	V
T _{op}	Operating Temperature Range	-40 to 85	°C
T _{stg}	Storage Temperature	-55 to 150	°C

Table 5. Electrical Characteristcs

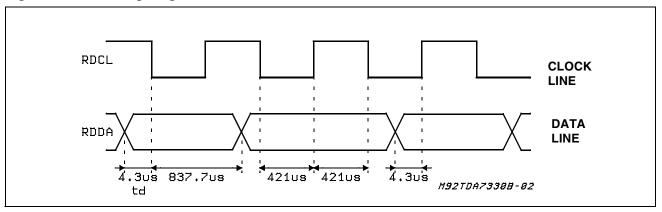
 $(T_{amb} = 25^{\circ}C, V_{S} = 5V, unless otherwise specified)$

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
Vs	Supply voltage		4.5	5	5.5	V
Is	Supply current			7.5	11.0	mA
FILTER						
f _C	Center frequency		56.5	57	57.5	kHz
BW	3dB Bandwidth		2.5	3	3.5	kHz
G	Gain	f = 57kHz	18	20	22	dB
Α	Attenuation	$\Delta f \pm 4kHz$	18	22		dB
		f = 38kHz	50	60		dB
		f = 67kHz	35	45		dB
R_{l}	Input impedance of MPX		80	120	150	KΩ
R_L	Load impedance on FILOUT		1			$M\Omega$
S/N	Signal to noise ratio	V _{IN} = 3mVRMS	30	40		dB
V _{IN}	MPX input signal	f = 19kHz; T3 ≤ 40dB ⁽¹⁾ f = 57kHz (RDS+ ARI)			1000 50	mV _{RMS} mV _{RMS}
S _{RDS}	RDS Detection Sensitivity		1			mVrms
S _{ARI}	ARI Detection Sensitivity		3			mVrms
V _{REF}	Reference			V _S /2		V
DEMODU	JLATOR	•	1	·		
Input pin Input pin	s (EXTRES, FSEL, TM) (OSEL)		all with ir with		ull down I pull up	
I _{PD}	Input Current	V _{IN} = 5V (pull-down input)	15		30	μΑ
I _{PU}	Input Current	V _{IN} = 0V (pull-up input)	-25		-10	μΑ
V _{IH}	Input voltage high		0.7 · V _S	$0.8 \cdot V_{S}$		V
VIL	Input voltage low			0.2 · V _S	$0.3 \cdot V_{S}$	V
Output p	ins (RDCL, RDDA, ARI, QUAL, T	57)	1	·		
V _{OH}	Ouput voltage high	$I_L = 0.5 \text{mA}$	4	4.6		V
V _{OL}	Output voltage low	$I_L = 0.5 \text{mA}$		0.4	1	V
OSCILLA	TOR	•	1	·		
VCLL	Input level OSCIN pin	OSEL = open circuit			1	V
VCLH	Input level OSCIN pin	OSEL = open circuit	4			V
	Amplitude OSCOUT	OSEL = open circuit		4.5		V
	Amplitude 030001					
V _{PP}	Amplitude OSCIN (for external drive)	OSEL = GND, f = 4.332MHz OSEL = GND, f = 8.664MHz		100 120		mVpp mVpp

⁽¹⁾ The 3rd harmonic (57kHz) must be less than -40dB with respect to the input signal plus gain.



Figure 4. RDS timing diagram



3 OUTPUT TIMING

The RDS (1187.5Hz) output clock on RDCL line is synchronized to the incoming data. According to the internal PLL lock condition data change can result on the falling or on the rising clock edge. (see Fig. 4)Whichever clock edge is used by the decoder (rising or falling edge) the data will remain valid for 416.7 µs after the clock transition.

4 OSCILLATOR CONTROLS (FSEL, OSEL)

Three different crystal frequencies can be used. The adaption of the internal clock divider to the external crystal is achieved via the input pin FSEL. See the following table for reference:

Table 6.

Crystal	FSEL (pin configuration)
4.332MHz 8.664MHz 17.328MHz	connected to GND or openconnected to Vs external resistor of 100K to Vs

A special mode is introduced to reduce EMI. With pin OSEL connected to GND the internal oscillator is switched off and an external sinusoidal frequency could be applied on OSCIN. The peak to peak voltage of this signal can be reduced down to 60mV.

In this mode the frequency selection via FSEL is still active.

Suggested values of C1 and C2 are shown in the following table:

Table 7.

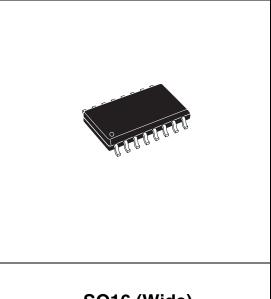
Crystal	C1	C2
4.332MHz 8.664MHz	27pF 27pF	47pF -
17.328MHz	27pF	-

Figure 5. SO16 Mechanical Data & Package Dimensions

DIM.		mm			inch	
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	2.35		2.65	0.093		0.104
A1	0.10		0.30	0.004		0.012
В	0.33		0.51	0.013		0.200
С	0.23		0.32	0.009		0.013
D ⁽¹⁾	10.10		10.50	0.398		0.413
Е	7.40		7.60	0.291		0.299
е		1.27			0.050	
Н	10.0		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.40		1.27	0.016		0.050
k		0	° (min.),	8° (max	.)	
ddd			0.10			0.004

^{(1) &}quot;D" dimension does not include mold flash, protusions or gate burrs. Mold flash, protusions or gate burrs shall not exceed 0.15mm per side.

OUTLINE AND MECHANICAL DATA



SO16 (Wide)

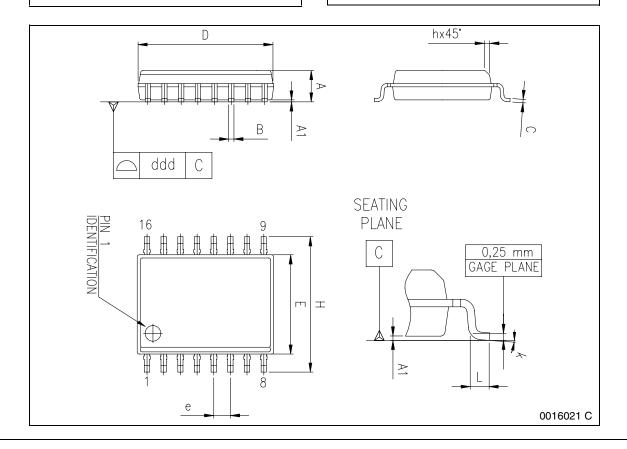


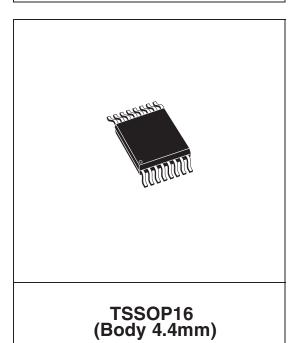
Figure 6. TSSOP16 Mechanical Data & Package Dimensions

DIM.		mm			inch	
DIW.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α			1.200			0.047
A1	0.050		0.150	0.002		0.006
A2	0.800	1.000	1.050	0.031	0.039	0.041
b	0.190		0.300	0.007		0.012
С	0.090		0.200	0.005		0.009
D (1)	4.900	5.000	5.100	0.114	0.118	0.122
Е	6.200	6.400	6.600	0.244	0.252	0.260
E1 (1)	4.300	4.400	4.500	0.170	0.173	0.177
е		0.650			0.026	
L	0.450	0.600	0.750	0.018	0.024	0.030
L1		1.000			0.039	
k	0° (min.) 8° (max.)					
aaa			0.100			0.004

Note: 1. D and E1 does not include mold flash or protrusions.

Mold flash or potrusions shall not exceed 0.15mm
(.006inch) per side.

OUTLINE AND MECHANICAL DATA



PIN 1

IDENTIFICATION

D

E1

E1

SEATING PLANE

O,25 mm

O10 inch

GAGE PLANE

5

0080338 (Jedec MO-153-AB)

Table 8. Revision History

Date	Revision	Description of Changes
September 2004	4	First Issue in EDOCS dms.
November 2004	5	Add in the table 5 "RDS and ARI Detection Sensitivity" parameters.
2 December 2004	6	Errata corrige of the Order Codes table.



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